SOT-23-3 Plastic-Encapsulate Transistors

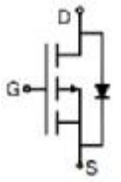
SI3401 MOSFET(P-Channel)

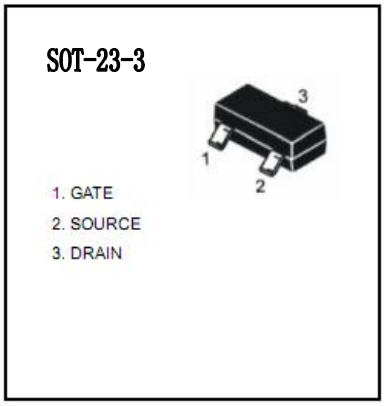
FEATURES

High Power and current handing capability

Lead free product is acquired

Surface Mount Package





MAXIMUM RATINGS (TA=25℃ unless otherwise noted)

Symbol	Parameter	Value	Units
V_{DS}	Drain-Source voltage	-30	V
V_{GS}	Gate-Source voltage	±12	V
I_D	Drain current	-4.2	A
P_D	Power Dissipation	1.2	W
Tj	Junction Temperature	-55-150	℃
Tstg	Storage Temperature	-55-150	℃

ELECTRICAL CHARACTERISTICS (Tamb=25℃unless otherwise specified)

Parameter	Symbol	Test conditions	MIN	TYP	MAX	UNIT
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V,I_D=-250uA	-30			V
Gate-Threshold Voltage	$V_{th(GS)}$	V_{DS}= V_{GS}, I_D=-250 uA	-0.7	-1	-1.4	V
Gate-body Leakage	I_{GSS}	V_{DS}=0V, V_{GS}=±12V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-30V, V_{GS}=0V			1	uA
Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS}=-2.5V, I_D=-1A			90	mΩ
		V_{GS}=-4.5V, I_D=-4A			75	mΩ
		V_{GS}=-10V, I_D=-4.2A			55	mΩ
Forward Trans conductance	gfs	V_{DS}=-5V, I_D=-4.2A		10		s
Dynamic Characteristics						
Input Capacitance	Ciss	V_{DS}=-15V, V_{GS}=0V, f=1MHz		950		pF
Output Capacitance	Coss			115		
Reverse Transfer Capacitance	Crss			75		
Switching Capacitance						
Turn-on Delay Time	$t_{d(on)}$	V_{DD}=-15V, I_D=-3.2A, V_{GS}=-10V R_{GEN}=6Ω		7		nS
Turn-on Rise Time	t_r			3		nS
Turn-off Delay Time	$t_{d(off)}$			30		nS
Turn-off Fall Time	t_f			12		nS
Total Gate Charge	Q_g	V_{DS}=-15V, I_D=-4A, V_{GS}=-4.5V,		9.5		nC
Gate-Source Charge	Q_{gs}			2		nC
Gate-Drain Charge	Q_{gd}			3		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage	V_{SD}	V_{GS}=0V, I_D=-1A			-1.2	V

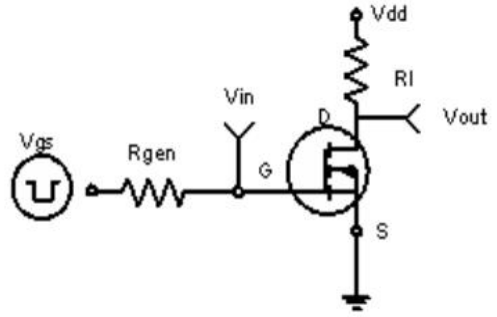


Figure 1:Switching Test Circuit

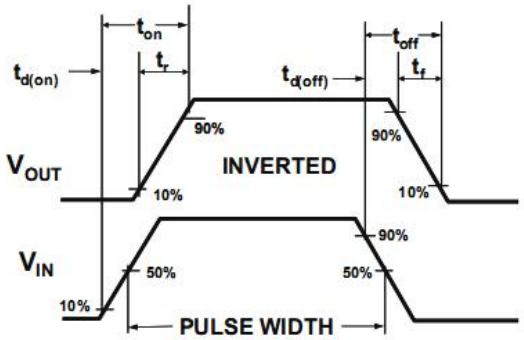


Figure 2:Switching Waveforms

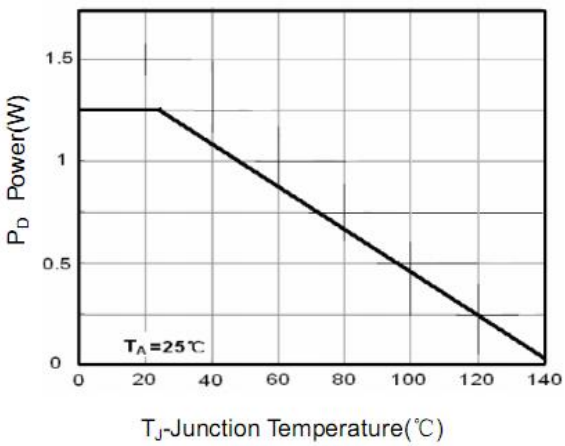


Figure 3 Power Dissipation

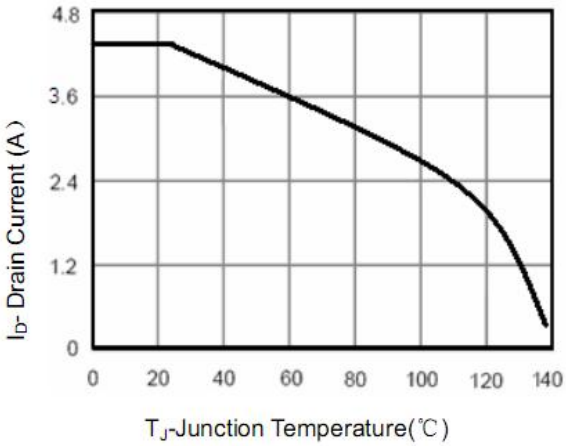


Figure 4 Drain Current

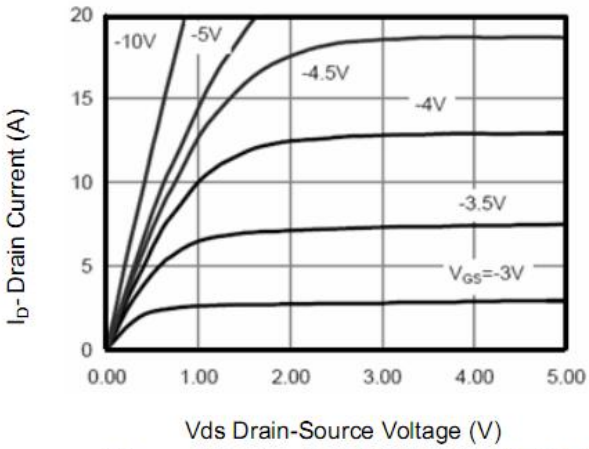


Figure 5 Output CHARACTERISTICS

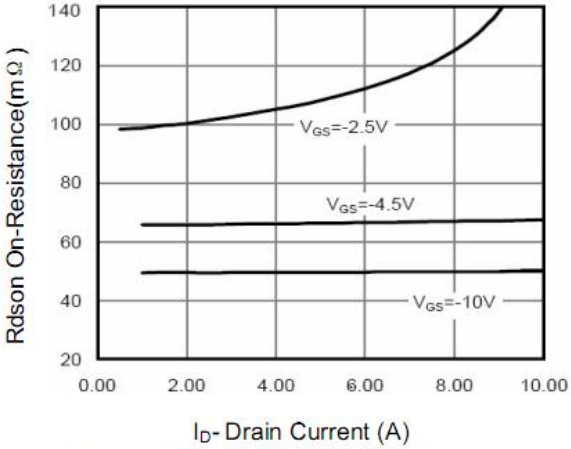


Figure 6 Drain-Source On-Resistance